# QCA402x Hardware Design Guidelines



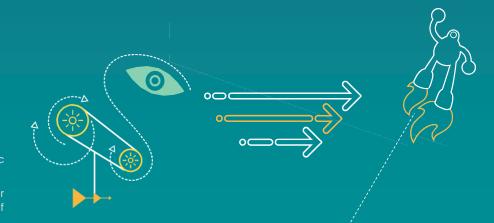
Qualcomm Technologies, Inc.

80-WL500-5 Rev. B

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## **Revision History**

Revision	Date	Description
А	April 2017	Initial release
В	August 2017	Updated for CS feature



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Section 1

## QCA402x Introduction

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Section 1.1

## Overview

## QCA402x - Hostless IoE Client Platform SoC

QCA4020: M4 CPU + CNSS + Dual Band 802.11abgn WLAN

QCA4024: M4 CPU + CNSS (15.4+BLE)

#### Features and packages:

- Dual Band 802.11 a/b/g/n Wi-Fi + Bluetooth Low Energy 5 + 802.15.4 connectivity (QCA4020)
- Bluetooth Low Energy 5 + 802.15.4 (QCA4024)
- A single regulated 3.3 V supply operation for QCA4020,
   QCA4024 (if VIO is 1.8 V, 1.8 VIO power supply required)
- Highly integrated WLAN SoC for 2.4/5G 802.11 abgn WLAN , BT LE and 802.15.4 technology
- Advanced Hardware-Based Security features in a low power, cost-optimized single-chip solution
- Support 20 MHz (and optionally 40 MHz) at 2.4 GHz and support 20/40 MHz at 5 GHz
- Support external PA for BLE and 802.15.4 with control logics
- Integrated Sensor Hub: for post-processing to enable the low power sensor use cases (1.8v IO only)

	QCA4020/4024	Schedule
CS		Sep 30, 2017





Parameter	Specification		
WLAN technology	802.11a/b/g/n with advanced features		
BT technology	BT Low Energy 5		
802.15.4 technology	802.15.4		
Best-in-class coexistence	Wi-Fi/BLE coexistence engine; BLE-802.15.4 coexistence		
Package	4020 • 1	117-ball MSP 1.2 mm×11.2 mm×0.876 mm 0.65 mm pitch	
COLUMN CO	4024 8	8-pin MQFN 3.0 mm×8.0 mm×0.85 mm 0.4 mm pitch	
Interfaces (supporting low power)	<ul> <li>SPI, UART, PWM, I2S, I2C, SDIO, and ADC as well as GPIOs</li> </ul>		
WLAN channel bandwidths	20/40 MHz		
WLAN TCIP/IP throughput	Hostless : > 20 Mbps		
WLAN maximum P <sub>OUT</sub> (at the balun)	<ul> <li>Up to +19 dBm (11b, 2.4 GHz)</li> <li>Up to +19 dBm (OFDM, 2.4 GHz)</li> <li>Up to +16 dBm (OFDM, 5 GHz)</li> </ul>		
BLE Rx sensitivity Tx output power (at chip output)	■ -96 dBm GFSK ■ +4 dBm		
15.4 Rx sensitivity Tx output power (at chip output)	<ul><li>-103 dBm (1% PER)</li><li>+4 dBm</li></ul>		
Power supply	Regulated 3.3 V, 1.8V (VIO if needs).		

## QCA402x - Hostless IoE Client Platform SoC

### QCA4020 (M4 CPU + CNSS + WLAN)

#### 1. ARM Cortex-M4F Application Processor

128 MHz, 692 KB ROM/RAM

#### 2. CNSS (Connectivity Subsystem)

- BLE 4.2: Host and Controller
- BT v5: 2 MbpsPHY, Adv length extensions
- 802.15.4 LMAC, PHY, encrypt/decrypt

#### 3. WLAN

- 1x1 dual-band 802.11abgn
- Tensilica LX processor
- STBC, TXBFee RX, Green TX, Low power listen, Fast RX antenna diversity.

#### 4. Co-existence

- Wi-Fi + BT + 802.15.4 Coex.
- Co-existence with an external device vis PTA 3-wires master interface.
- Antennas options vs co-existing (see next page).

#### 5. External QSPI serial Flash

- Low speed: 8 MHz at boot-up
- High speed: Either 64 MHz or 96 MHz QSPI access.

#### 6. Host-less mode

SPI Master or SDIO Slave interface with other Host

#### 7. PMU

- 1.8 V/3.3 V IO support. (1.8 V only for ES).
- 1.1 V Buck converters for internal Digital/Analog

#### 8. Package

 11.2x11.2 mm VFBGA217, 0.65 mm pitch for 4-layer PCB design.

### QCA4024 (M4 CPU + CNSS)

- 1. ARM Cortex-M4F Application Processor
  - 128 MHz, 692 KB RAM.
- 2. CNSS (Connectivity Subsystem)
  - Cortex M0 connectivity processor
  - BLE 4.2: Host and Controller
  - BT v5: 2 MbpsPHY, Adv length extensions
  - IEEE802.15.4 v2006 with CSL feature

#### 3. Co-existence

- BT + 802.15.4 Coex.
- Configurable Priority Assignment
- Co-existence with an external device vis 3-wire PTA master/slave interface.
- Antennas options vs co-existing (see next page).

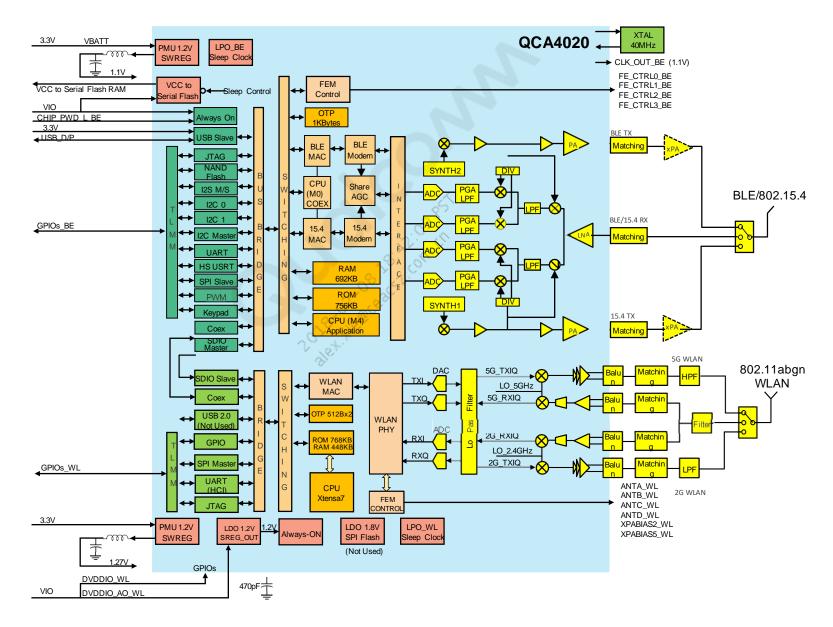
#### 4. External QSPI serial Flash

- 8 MHz at boot-up
- Either 64 MHz or 96 MHz 4-bits access.
- 5. Host-less mode
- 6. PMU
  - VBATT: 1.8 V ~ 3.6 V
  - 1.8 V/3.3 V IO support. (1.8 V only for ES).
  - 1.8 V LDO for IO voltage
  - 1.1 V Buck converter for internal Digital/Analog

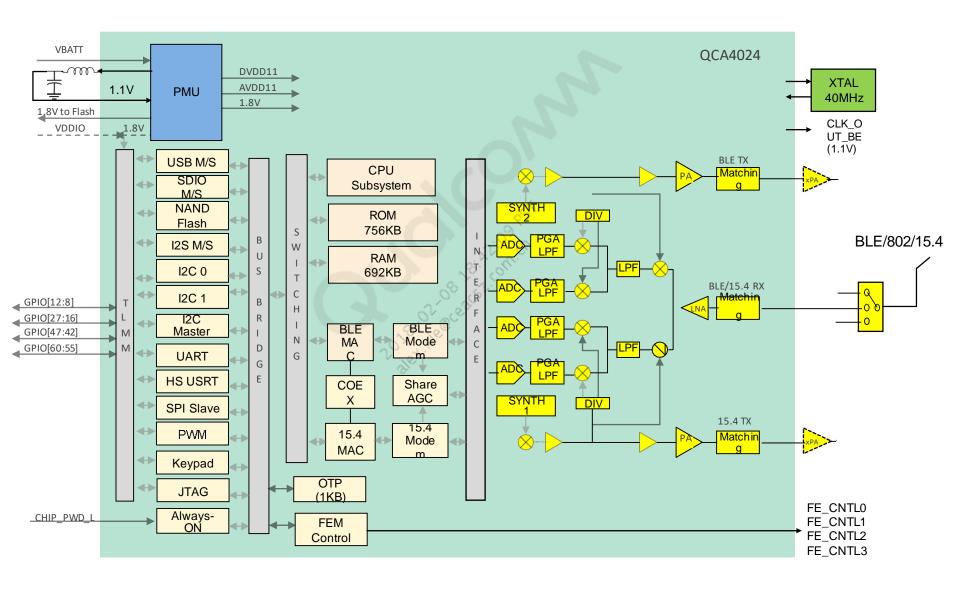
#### 7. Package

 8x8 mm, MQFN68, 0.4 mm pitch for either 2layer or 4-layer PCB design.

#### **QCA4020 Architecture**



#### **QCA4024 Architecture**



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